

# Single N-channel MOSFET

ELM14444AA-N

## General description

ELM14444AA-N uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and low gate resistance.

## Features

- $V_{ds}=30V$
- $I_d=20A$  ( $V_{gs}=10V$ )
- $R_{ds(on)} < 5.5m\Omega$  ( $V_{gs}=10V$ )
- $R_{ds(on)} < 7.5m\Omega$  ( $V_{gs}=4.5V$ )

## Maximum absolute ratings

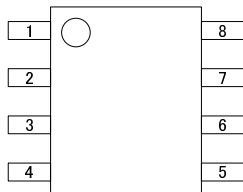
Parameter	Symbol	Limit	Unit	Note	
Drain-source voltage	$V_{ds}$	30	V		
Gate-source voltage	$V_{gs}$	$\pm 20$	V		
Continuous drain current	$I_d$	$T_a=25^\circ C$	20	A	1
		$T_a=70^\circ C$	17		
Pulsed drain current	$I_{dm}$	80	A	2	
Power dissipation	$P_d$	$T_a=25^\circ C$	3.0	W	
		$T_a=70^\circ C$	2.1		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	$^\circ C$		

## Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R\theta_{ja}$	31	40	$^\circ C/W$	1
	Steady-state		59	75	$^\circ C/W$	
Maximum junction-to-lead	Steady-state	$R\theta_{jl}$	16	24	$^\circ C/W$	3

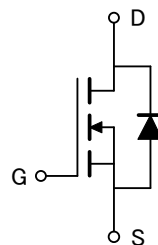
## Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

## Circuit



# Single N-channel MOSFET

ELM14444AA-N

## Electrical characteristics

T<sub>a</sub>=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	BV <sub>dss</sub>	I <sub>d</sub> =250 μA, V <sub>gs</sub> =0V	30			V
Zero gate voltage drain current	I <sub>dss</sub>	V <sub>ds</sub> =24V			1	μA
		V <sub>gs</sub> =0V		T <sub>j</sub> =55°C	5	
Gate-body leakage current	I <sub>gss</sub>	V <sub>ds</sub> =0V, V <sub>gs</sub> =±20V			100	nA
Gate threshold voltage	V <sub>gs(th)</sub>	V <sub>ds</sub> =V <sub>gs</sub> , I <sub>d</sub> =250 μA	1.0	1.8	3.0	V
On state drain current	I <sub>d(on)</sub>	V <sub>gs</sub> =10V, V <sub>ds</sub> =5V	60			A
Static drain-source on-resistance	R <sub>ds(on)</sub>	V <sub>gs</sub> =10V		3.9	5.5	mΩ
		I <sub>d</sub> =20A	T <sub>j</sub> =125°C	5.1	6.2	
		V <sub>gs</sub> =4.5V, I <sub>d</sub> =15A		5.1	7.5	mΩ
Forward transconductance	G <sub>fs</sub>	V <sub>ds</sub> =5V, I <sub>d</sub> =20A		106		S
Diode forward voltage	V <sub>sd</sub>	I <sub>s</sub> =1A, V <sub>gs</sub> =0V		0.72	1.00	V
Max. body-diode continuous current	I <sub>s</sub>				4	A
<b>DYNAMIC PARAMETERS</b>						
Input capacitance	C <sub>iss</sub>			3200	3840	pF
Output capacitance	C <sub>oss</sub>	V <sub>gs</sub> =0V, V <sub>ds</sub> =15V, f=1MHz		590		pF
Reverse transfer capacitance	C <sub>rss</sub>			414		pF
Gate resistance	R <sub>g</sub>	V <sub>gs</sub> =0V, V <sub>ds</sub> =0V, f=1MHz		0.54	0.70	Ω
<b>SWITCHING PARAMETERS</b>						
Total gate charge (10V)	Q <sub>g</sub>	V <sub>gs</sub> =4.5V, V <sub>ds</sub> =15V, I <sub>d</sub> =20A		63.0	76.0	nC
Total gate charge (4.5V)	Q <sub>g</sub>			33.0	40.0	nC
Gate-source charge	Q <sub>gs</sub>			8.6		nC
Gate-drain charge	Q <sub>gd</sub>			17.6		nC
Turn-on delay time	t <sub>d(on)</sub>			12.0		ns
Turn-on rise time	t <sub>r</sub>	V <sub>gs</sub> =10V, V <sub>ds</sub> =15V		15.5		ns
Turn-off delay time	t <sub>d(off)</sub>	R <sub>l</sub> =0.75 Ω, R <sub>gen</sub> =3 Ω		40.0		ns
Turn-off fall time	t <sub>f</sub>			14.0		ns
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>f</sub> =20A, dI/dt=100A/μs		34	41	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>f</sub> =20A, dI/dt=100A/μs		30		nC

### NOTE :

1. The value of R<sub>θja</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with T<sub>a</sub>=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R<sub>θja</sub> is the sum of the thermal impedance from junction to lead R<sub>θjl</sub> and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>a</sub>=25°C. The SOA curve provides a single pulse rating.

# Single N-channel MOSFET

ELM14444AA-N

## Typical electrical and thermal characteristics

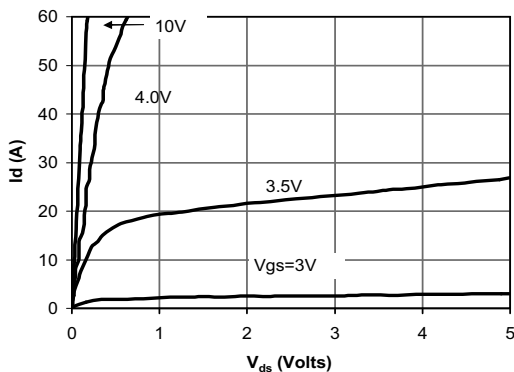


Fig 1: On-Region Characteristics

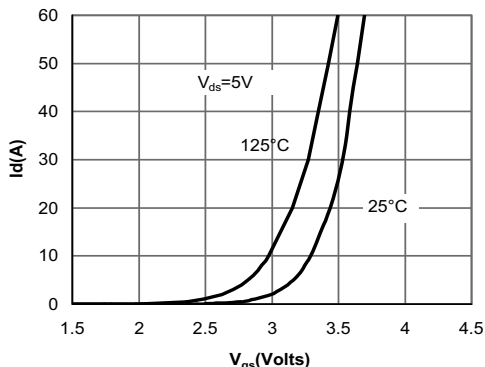


Figure 2: Transfer Characteristics

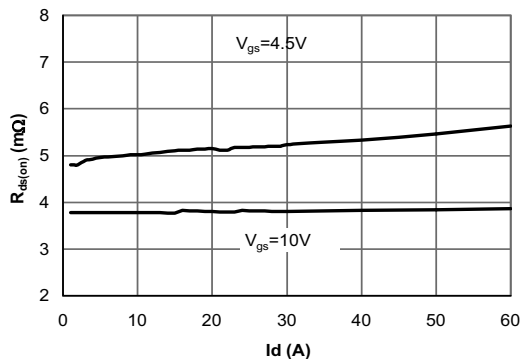


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

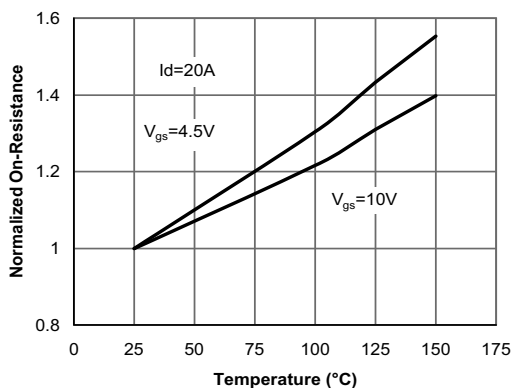


Figure 4: On-Resistance vs. Junction Temperature

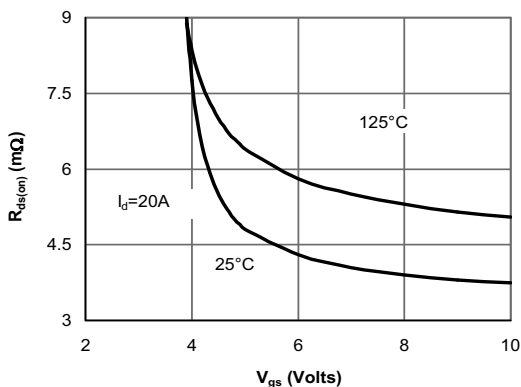


Figure 5: On-Resistance vs. Gate-Source Voltage

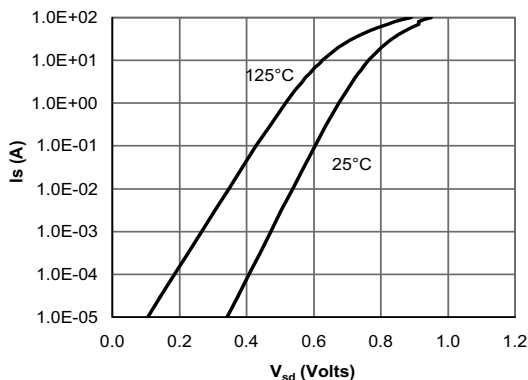


Figure 6: Body-Diode Characteristics

# Single N-channel MOSFET

ELM14444AA-N

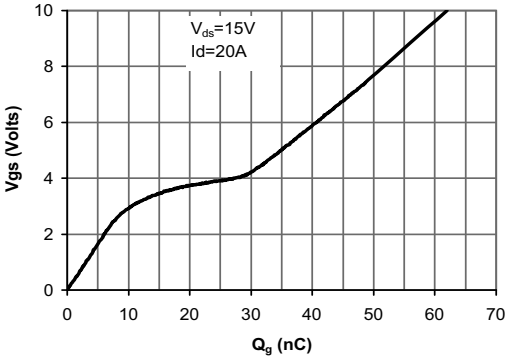


Figure 7: Gate-Charge Characteristics

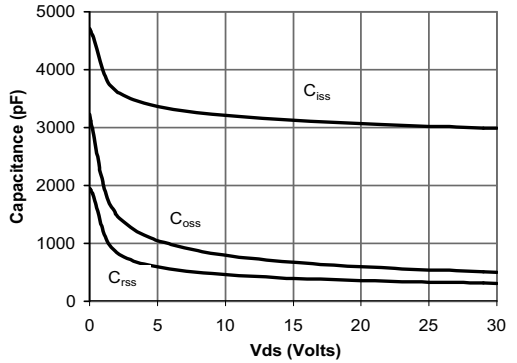


Figure 8: Capacitance Characteristics

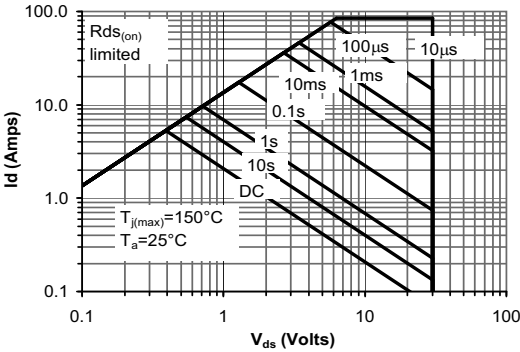


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

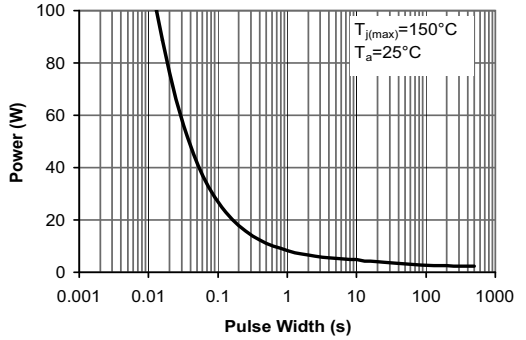


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

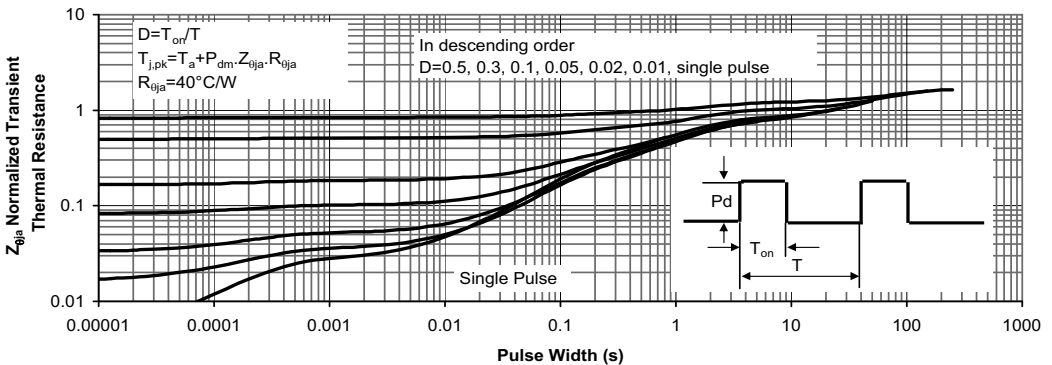


Figure 11: Normalized Maximum Transient Thermal Impedance